

## 24-Channel Intelligent 8-Bit RGB LED Driver

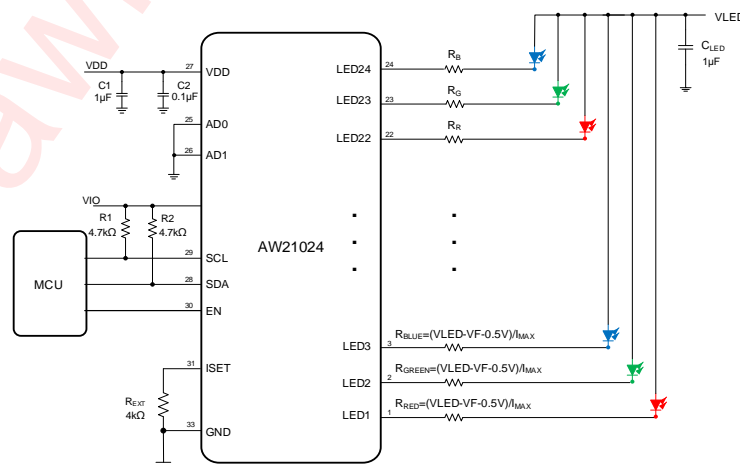
### Features

- 24-channel RGB LED Driver
  - Global 256-level DC current configuration
  - Individual 256-level PWM for dimming
  - Individual 256-level current for color-mixing
- High-precision current sinks
  - Device-to-device error:  $\pm 5\%$
  - Channel-to-channel error:  $\pm 5\%$
- EMI and audible noise reduction
  - Phase delay and phase inverting scheme
  - Spread spectrum function
- Flexible LED lighting pattern control
- LED open/short detection per channel
- Auto power saving mode when all LEDs off > 32ms
- Over-temperature protection
- 400kHz I<sup>2</sup>C interface, 16 selectable addresses
- Power supply: 2.7V~5.5V
- QFN 4mmX4mmX0.85mm-32L package

### Applications

Smart speaker  
E-sports devices  
Smart home appliance

### Typical Application Circuit



Note: The resistors( $R_a$ ,  $R_b$ ,  $R_c$ ,  $R_d$ ) between LED and IC are only for thermal reduction. For more information, please refer to application information.

Figure 1 AW21024 Application Circuit

### General Description

AW21024 is a 24-channel high precision constant current LED driver. Each channel has individual 8-bit DC current setting for color-mixing and 8-bit PWM current for brightness control. The maximum global current of each channel is recommended to be 50mA configured via internal register and external resistor  $R_{EXT}$ .

Group control mode, autonomous breathing pattern and rapid RGB control mode are provided for flexible, high efficiency lighting effect programming and fast display updating.

Programmable phase-shifting and spread spectrum technology are utilized to reduce EMI and audible noise caused by MLCC when LEDs turn on or off simultaneously.

AW21024 can be turned off with minimum current consumption by pulling the EN pin low.

AW21024 operates from 2.7V to 5.5V over the temperature range of  $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$ .

## Pin Configuration And Top Mark

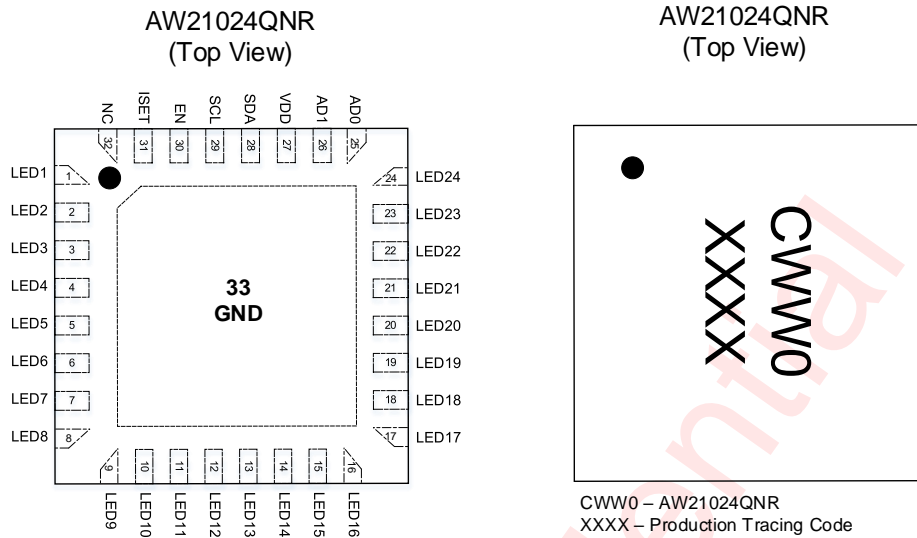


Figure 2 Pin Configuration and Marking

## Pin Definition

No.	NAME	DESCRIPTION
1~24	LED1~LED24	Constant current sink, connect to LED's cathode
25~26	AD0, AD1	I <sup>2</sup> C address setting, connects to GND, VDD, SCL or SDA for different device address of I <sup>2</sup> C. Internally pulled down to GND with a resistor of 1M $\Omega$ .
27	VDD	Power supply
28	SDA	Serial data I/O for I <sup>2</sup> C interface
29	SCL	Serial clock input for I <sup>2</sup> C interface
30	EN	Shutdown the chip when pulled low.
31	ISET	Input terminal used to connect an external resistor. This regulates the global output current. When R <sub>EXT</sub> =4.0k $\Omega$ , global current of LED is 20mA.
32	NC	Not connected
33	GND	Ground

### Functional Block Diagram

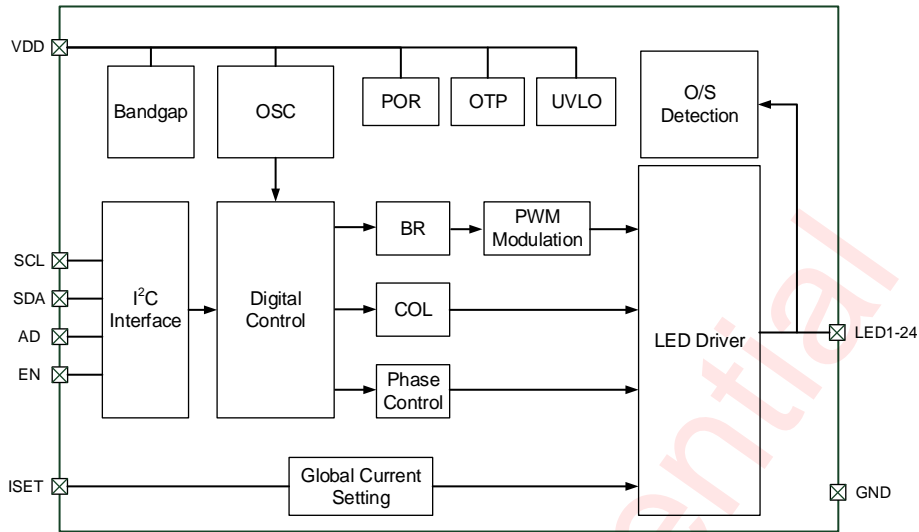
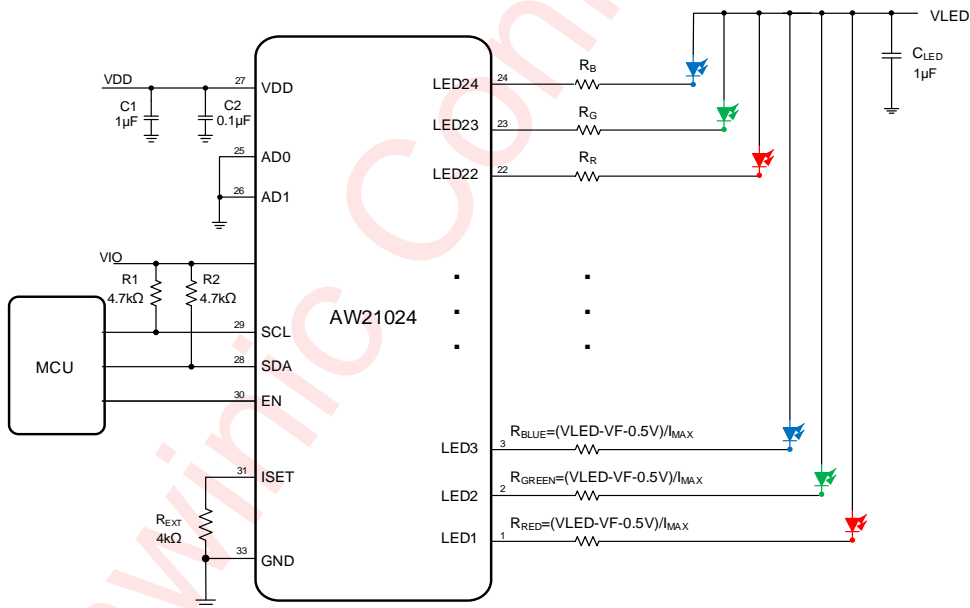


Figure 3 Functional Block Diagram

### Typical Application Circuits



Note: The resistors (R<sub>R</sub>, R<sub>G</sub>, R<sub>B</sub>) between LED and IC are only for thermal reduction. For more information, please refer to application information.

Figure 4 AW21024 Application Circuit

### Ordering Information

Part Number	Temperature	Package	Marking	Moisture Sensitivity Level	Environmental Information	Delivery Form
AW21024QNR	-40°C~85°C	QFN 4mmX4mm-32L	CWW0	MSL3	ROHS+HF	6000 units/ Tape and Reel

## Absolute Maximum Ratings<sup>(NOTE1)</sup>

PARAMETERS		RANGE
Supply voltage range VDD		-0.3V to 6V
Input voltage range	SCL, SDA, EN, AD0, AD1	-0.3V to 6V
Output voltage range	LED1~LED24	-0.3V to 6V
Junction-to-ambient thermal resistance $\theta_{JA}$		44.4°C/W
Operating free-air temperature range		-40°C to 85°C
Maximum operating junction temperature $T_{JMAX}$		160°C
Storage temperature $T_{STG}$		-65°C to 150°C
Lead temperature (soldering 10 seconds)		260°C
ESD <sup>(NOTE2)</sup>		
HBM		±2kV
CDM		±1.5kV
Latch-Up		
Test condition: JESD78E		+IT: 200mA -IT: -200mA

**NOTE1:** Conditions out of those ranges listed in "absolute maximum ratings" may cause permanent damages to the device. In spite of the limits above, functional operation conditions of the device should within the ranges listed in "recommended operating conditions". Exposure to absolute-maximum-rated conditions for prolonged periods may affect device reliability.

**NOTE2:** The human body model is a 100pF capacitor discharged through a 1.5kΩ resistor into each pin. Test method: MIL-STD-883H Method 3015.8(HBM) ESDA/JEDEC JS-002-2018(CDM)

## Recommended Operating Conditions

Symbol	Parameter	Min.	Typ.	Max.	Unit
$T_A$	Operating free-air temperature range	-40		85	°C
VDD	Input voltage	2.7		5.5	V
LED1~LED24	Voltage on LEDx	0		5.5	V
$C_1, C_{LED}$	Input capacitance	1		22	μF
$C_2$	Input capacitance	0.1		1	μF
$R_1, R_2$	External resistor for I <sup>2</sup> C	1	4.7	10	kΩ
$R_{EXT}$	External resistor for setting sink current	1.6	4	20	kΩ

## Electrical Characteristics

T<sub>A</sub>=25°C, R<sub>EXT</sub>=4kΩ, VDD=2.7~5.5V (unless otherwise noted)

PARAMETER		TEST CONDITION	MIN	TYP	MAX	UNIT
<b>Power supply voltage and current</b>						
VDD	Power supply voltage		2.7		5.5	V
I <sub>SD_VDD</sub>	Shutdown current of VDD	EN=GND		0.1	1	μA
I <sub>STB_VDD</sub>	Standby current of VDD	V <sub>EN</sub> =3.3V, CHIPEN=0		3	25	μA
	Power-save mode current consumption	V <sub>EN</sub> =3.6V, GCR.APSE=1, All LEDs off >32ms		3	25	μA
I <sub>ACT_VDD</sub>	Quiescent current in active mode	V <sub>EN</sub> =VDD, GCR.CHIPEN=1,		2	4	mA
		V <sub>EN</sub> =VDD, GCR.CHIPEN=1, GCCR.GCC=0xFF, COL <sub>X</sub> =0xFF		10	16	mA
I <sub>LEAKAGE</sub>	Output leakage current	V <sub>EN</sub> =0V, VLED <sub>X</sub> =5.5V		0.1	1	uA
I <sub>MAX</sub>	Maximum global current of LED <sub>X</sub>	GCCR.GCC=0xFF, BR <sub>X</sub> =COL <sub>X</sub> =0xFF	-5%	20.0	+5%	mA
I <sub>MATCH</sub>	Output current match accuracy	GCCR.GCC=0xFF, BR <sub>X</sub> =COL <sub>X</sub> =0xFF	-5		+5	%
V <sub>DROPOUT</sub>	Dropout voltage when the LED current has dropped 10%	I <sub>LED<sub>X</sub></sub> =20mA		120	250	mV
F <sub>OSC</sub>	OSC clock frequency		-5%	16	+5%	MHz
T <sub>SD</sub>	Thermal shutdown threshold			150		°C
	Thermal shutdown hysteresis			20		°C
<b>AD0, AD1, EN</b>						
V <sub>IL</sub>	Input low level	AD0, AD1, EN			0.4	V
V <sub>IH</sub>	Input high level	AD0, AD1, EN	1.2			V
R <sub>ADPD</sub>	Internal pull down resistance	AD0, AD1, VDD=3.6V		1M		Ω
R <sub>ENPD</sub>	Internal pull down resistance	EN, VDD=3.6V		400k		Ω
<b>I<sup>2</sup>C Interface</b>						
V <sub>OL</sub>	Output low level	SDA, I <sub>OL</sub> = 10mA			0.1	V
V <sub>IH</sub>	Input high level	SCL, SDA	1.2			V
V <sub>IL</sub>	Input low level	SCL, SDA			0.4	V

## I<sup>2</sup>C Interface Timing

PARAMETER		MIN	TYP	MAX	UNIT
F <sub>SCL</sub>	Interface Clock frequency	-		400	kHz
T <sub>HD:STA</sub>	(Repeat-start) Start condition hold time	0.6		-	μs
T <sub>LOW</sub>	Low level width of SCL	1.3		-	μs
T <sub>HIGH</sub>	High level width of SCL	0.6		-	μs
T <sub>SU:STA</sub>	(Repeat-start) Start condition setup time	0.6		-	μs
T <sub>HD:DAT</sub>	Data hold time	0		-	μs
T <sub>SU:DAT</sub>	Data setup time	0.1		-	μs
T <sub>R</sub>	Rising time of SDA and SCL	-		0.3	μs
T <sub>F</sub>	Falling time of SDA and SCL	-		0.3	μs
T <sub>SU:STO</sub>	Stop condition setup time	0.6		-	μs
T <sub>BUF</sub>	Time between start and stop condition	1.3		-	μs

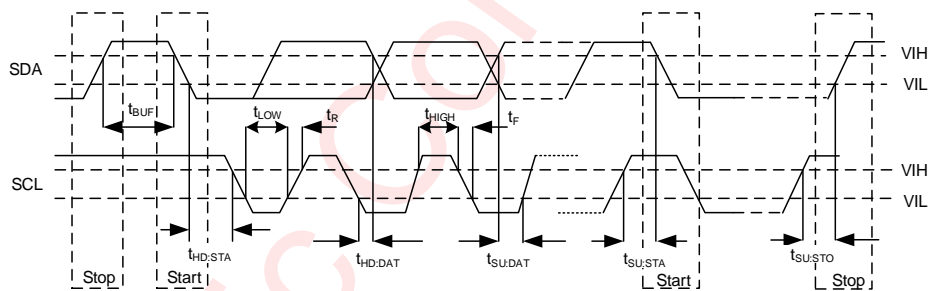


Figure 5 I<sup>2</sup>C Interface Timing

## Detailed Functional Description

### Operation Mode And Reset

#### Power On Reset

Upon initial power-up, the AW21024 is reset by internal power-on-reset, and all registers are reset to default value, and LED driver is shut down.

Once the supply voltage VDD drops below the threshold voltage  $V_{POR\_VDD}$  (2.0V), the power-on-reset will be activated to reset the device again. By reading the bit PORST of the register UVCR (address 79h), whether the device has been reset can be determined.

Below is the recommended operation timing:

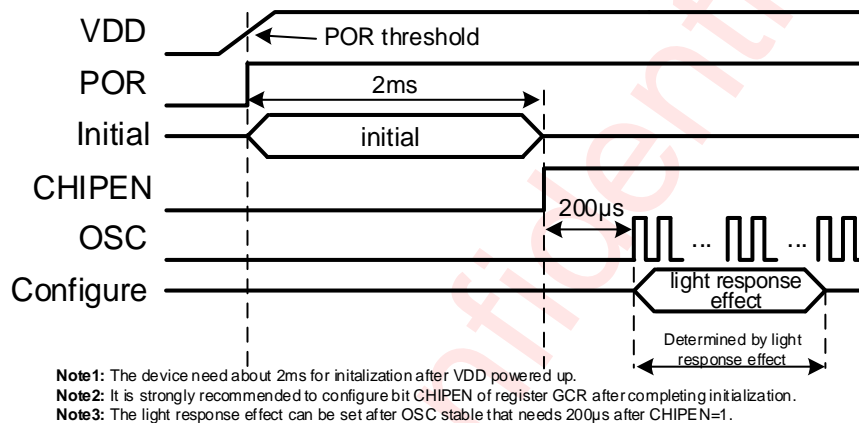


Figure 6 Power Up Timing

#### Software Reset

By writing 00H to register RESET (address 7Fh), the software reset is triggered. After software reset, all registers will be reset to the default value and enter into standby mode.

After the software reset command is input through I<sup>2</sup>C or power on reset, it needs to wait at least 2ms before any other I<sup>2</sup>C command can be accepted.

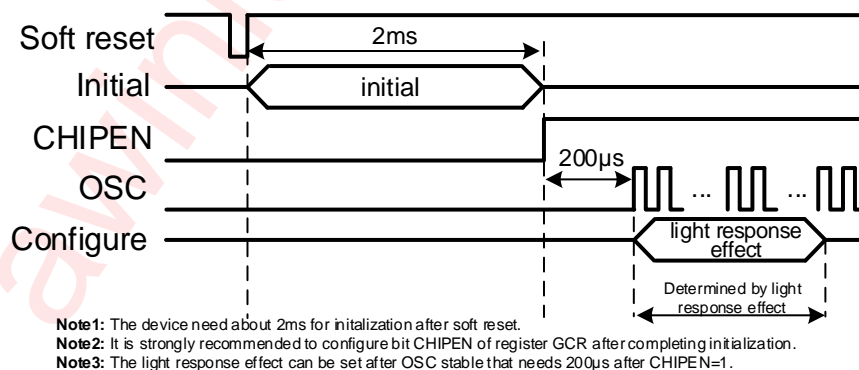


Figure 7 Software Reset Timing

#### Shutdown Mode

The AW21024 enters into shutdown mode automatically when EN is pulled to low level. In this situation, I<sup>2</sup>C interface is not accessible, all registers can not be configured and will be reset.

### Standby Mode

After initialization, the AW21024 enters into standby mode automatically when EN is high and the bit CHIPEN of the register GCR (address 00h) is set to "0". In standby mode, all analog blocks except POR are power down but I<sup>2</sup>C interface is accessible, and all registers can be configured.

### Active Mode

When EN is in high level, and the bit CHIPEN of the register GCR (address 00h) is set to "1", the AW21024 enters into the active mode.

### Auto Power-Save Mode

The bit APSE of the register GCR (address 00h) is set to "1", the auto power-save mode is enabled. When all LEDs are off and the value of all register BR0~BR23 are 0x00 for more than 32ms, AW21024 automatically enters into standby mode for power saving. Once writing a non-zero value into any register among BR0~BR23, the device exits power-save mode immediately.

In addition, the auto power-save mode is disabled under autonomous breathing mode.

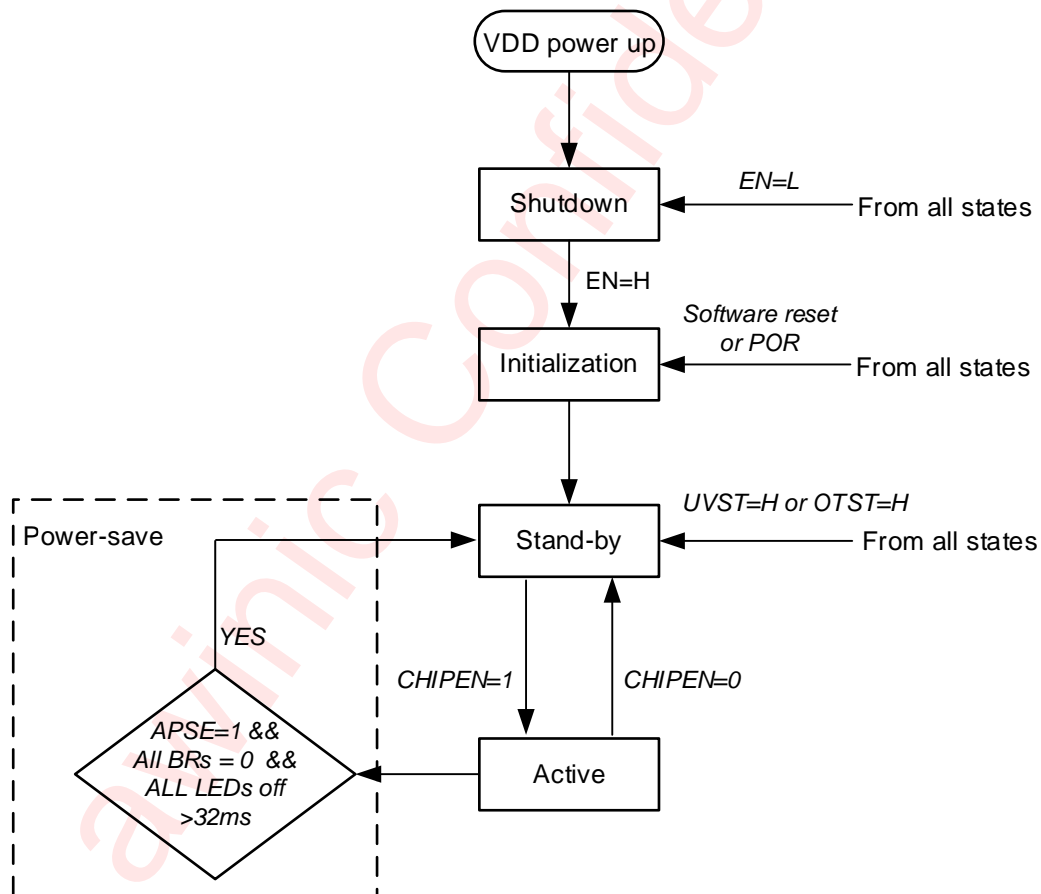


Figure 8 AW21024 Operating Mode Transition



## I<sup>2</sup>C Interface

The AW21024 supports the I<sup>2</sup>C protocol. The maximum frequency supported by the I<sup>2</sup>C is 400kHz. The pull-up resistors for the SDA and SCL can be selected from 1kΩ to 10kΩ. Usually, 4.7kΩ is recommended for 400kHz I<sup>2</sup>C. The voltage from 1.8V to 3.3V is allowed for the I<sup>2</sup>C interface. Additionally, the I<sup>2</sup>C device supports continuous read and write operations.

### Device Address

The I<sup>2</sup>C device address is 7-bit (A7~A1), followed by a R/W bit A0 (Read=1/Write=0). Set A0 to “0” for writing and “1” for reading. The values of bit A1 and bit A2 are depended on the connection of pin AD1 and the values of [A4: A3] are depended on the connection of pin AD0, there are 4 options: VDD, GND, SCL and SDA for each AD. The A7 to A5 is “011” constantly. The device also supports using a broadcast slave address of 1Ch to access registers. All slave addresses as followed.

AD1	AD0	A7:A5	A4:A3	A2:A1	A0	Device Address	Broadcast Address
GND	GND	011	00	00	0/1	30h	1Ch
VDD	GND		00	01		31h	
SCL	GND		00	10		32h	
SDA	GND		00	11		33h	
GND	VDD		01	00		34h	
VDD	VDD		01	01		35h	
SCL	VDD		01	10		36h	
SDA	VDD		01	11		37h	
GND	SCL		10	00		38h	
VDD	SCL		10	01		39h	
SCL	SCL		10	10		3ah	
SDA	SCL		10	11		3bh	
GND	SDA		11	00		3ch	
VDD	SDA		11	01		3dh	
SCL	SDA		11	10		3eh	
SDA	SDA		11	11		3fh	

### I<sup>2</sup>C Start/Stop

I<sup>2</sup>C start: SDA changes from high level to low level when SCL is high level.

I<sup>2</sup>C stop: SDA changes from low level to high level when SCL is high level.

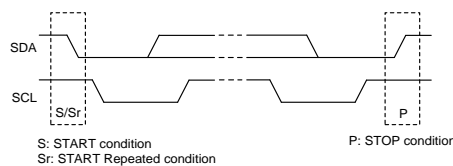


Figure 9 I<sup>2</sup>C Start/Stop Condition Timing

## Data Validation

When SCL is high level, SDA level must be constant. SDA can be changed only when SCL is low level.

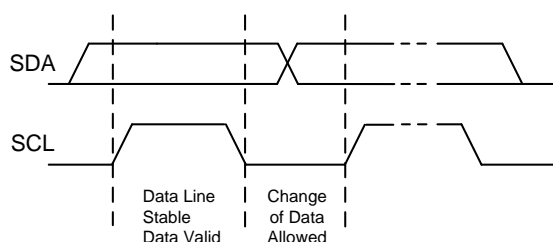


Figure 10 Data Validation Diagram

## ACK (Acknowledgement)

ACK means the successful transfer of I<sup>2</sup>C bus data. After master sends an 8-bit data, SDA must be released; SDA is pulled to GND by slave device when slave acknowledges.

When master reads, slave device sends 8-bit data, releases the SDA and waits for ACK from master. If ACK is sent and I<sup>2</sup>C stop is not sent by master, slave device sends the next data. If ACK is not sent by master, slave device stops to send data and waits for I<sup>2</sup>C stop.

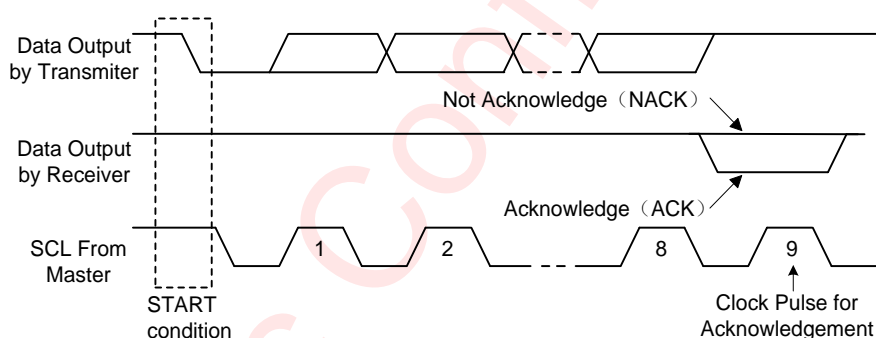


Figure 4 I<sup>2</sup>C ACK Timing

## Write Cycle

One data bit is transferred during each clock pulse. Data is sampled during the high state of the serial clock (SCL). Consequently, throughout the clock's high period, the data should remain stable. Any changes on the SDA line during the high state of the SCL and in the middle of a transaction, aborts the current transaction. New data should be sent during the low SCL state. This protocol allows a single data line to transfer both command/control information and data using the synchronous serial clock.

Each data transaction is composed of a start condition, a number of byte transfers (set by the software) and a stop condition to terminate the transaction. Every byte written to the SDA bus must be 8 bits long and is transferred with the most significant bit first. After each byte, an Acknowledge signal must follow.

In a write process, the following steps should be followed:

- Master device generates START condition. The "START" signal is generated by lowering the SDA signal while the SCL signal is high.
- Master device sends slave address (7-bit) and the data direction bit (R/W = 0).
- Slave device sends acknowledge signal if the slave address is correct.
- Master sends control register address (8-bit).
- Slave sends acknowledge signal.

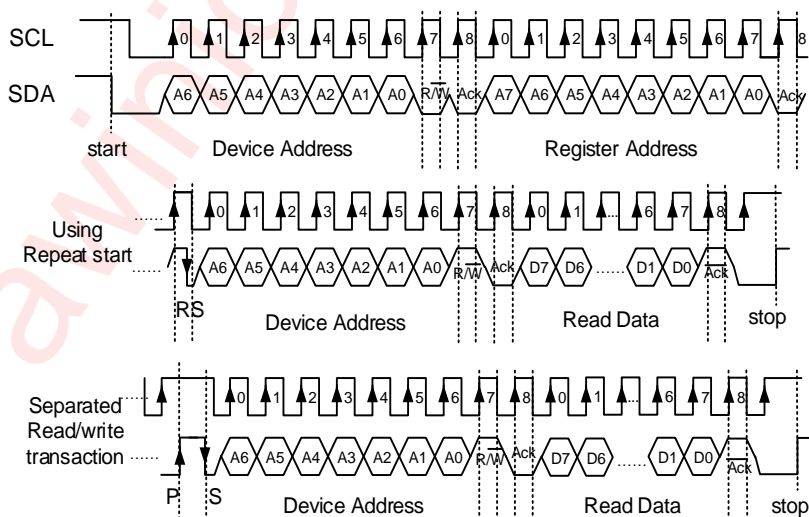
- f) Master sends data byte to be written to the addressed register.
- g) Slave sends acknowledge signal.
- h) If master will send further data bytes the control register address will be incremented by one after acknowledge signal (repeat step f and g).
- i) Master generates STOP condition to indicate write cycle end.

Figure 5 I<sup>2</sup>C Write Byte Cycle

### Read Cycle

In a read cycle, the following steps should be followed:

- a) Master device generates START condition.
- b) Master device sends slave address (7-bit) and the data direction bit (R/W = 0).
- c) Slave device sends acknowledge signal if the slave address is correct.
- d) Master sends control register address (8-bit).
- e) Slave sends acknowledge signal.
- f) Master generates STOP condition followed with START condition or REPEAT START condition.
- g) Master device sends slave address (7-bit) and the data direction bit (R/W = 1).
- h) Slave device sends acknowledge signal if the slave address is correct.
- i) Slave sends data byte from addressed register.
- j) If the master device sends acknowledge signal, the slave device will increase the control register address by one, then send the next data from the new addressed register.
- k) If the master device generates STOP condition, the read cycle is ended.

Figure 6 I<sup>2</sup>C Read Byte Cycle

## Under Voltage Lock Out (UVLO)

When bit UVDIS of the register UVCR (address 79h) is set to “0”, the device monitors the voltage of VDD. If the voltage drops below threshold (2.4V typically), the bit UVST of the register UVCR (address 79h) will be set to “1”. After read-out, the register UVCR will be clear.

If both bit UVDIS and bit UVPD of the register UVCR (address 79h) is set to “0”, UVLO protection function is enabled. Once the event of under voltage occurs, the bit CHIPEN of the register GCR (address 00h) will be cleared to “0”, and then the device will enter into standby mode. If the voltage of VDD rises above the UVLO threshold and then write “1” to bit CHIPEN, the device will enter into active mode again.

By default, control bits UVDIS, UVPD are all “0”. Both UVLO monitor and protection are enabled.

## Over Temperature Protection (OTP)

When bit OTDIS of the register OTCR (address 77h) is set to “0”, the over-temperature detection is enabled. Once the temperature of this device reaches 150°C, the over-temperature condition is detected, and the bit OTST of the register OTCR (address 77h) will be set to “1”. The OTST will be cleared to “0” after reading the register OTCR.

If both bit OTDIS and bit OTPD of the register OTCR (address 77h) is set to “0”, the Over-Temperature Protection (OTP) function is enabled. Once the event of over-temperature occurs, the bit CHIPEN of the register GCR (address 00h) will be cleared to “0”, and then the device will enter into standby mode. When the temperature returns below 130°C, the device will enter into active mode again after writing “1” to bit CHIPEN.

By default, control bits OTDIS and OTPD are all “0”, both OT monitor and OT protection are enabled.

## LED Open/Short Detection

AW21024 supports LED open/short detection. When bit OSDE[1:0] of the register OSDCR(address 71h) is set to “11”, open detection is enabled, and the detection results can be read out via the registers OSST0~2 (72h~74h). Similarly, when set bit OSDE [1:0] of the register OSDCR (address 71h) to “10”, short detection is enabled, and the results also can be read out via the registers OSST0~2.

We recommend the bit PWMDIS [6:5] of the register SSCR (address 78h) being set to “11” and maintain about 1mA current of each LED when the open/short function is enabled.

## Current Setting

The average output current of LED<sub>n</sub> (n=1, 2, ..., 24) can be expressed by the following formula,

$$I_{OUT(n)} = K \times \frac{V_{REXT}}{R_{EXT}} \times \frac{GCC}{255} \times \frac{WB}{255} \times \frac{COL_n}{255} \times \frac{BR_n}{256} \quad n=1, 2, 3, \dots, 24$$

Where  $V_{REXT}=0.4V$ ,  $K=200$ ,  $R_{EXT}$  is the value of external resistor,  $GCC$  is the 8bit global current configured by the register GCCR (address 6Eh),  $WB$  is 8bit white balance parameter configured by the register WBR/WBG/WBB (address 90h/91h/92h),  $COL_n$  is 8bit individual constant current parameter, and  $BR_n$  is 8bit individual PWM modulated current parameter.

The average output current is determined by the global current(controlled by  $R_{EXT}$ ,  $GCC$ ,  $WB$  and  $COL$ ) and PWM duty cycle(controlled by  $BR$ ). For example  $R_{EXT}=4k\Omega$ ,  $GCC=COL=WB=BR=0xFF$ . The global current is 20mA, the average output current is slightly less than 20mA because the maximum PWM duty cycle(=255/256) can't reach 100%.

**Notes:** If application needs 100% duty cycle please refer to PWM Disable.

AW21024 supports white balance calibration function via 3 registers consisting of register WBR, WBG, and WBB. Therein, WBR is used for LED<sub>x</sub> (X=1, 4, 7, ..., 22), WBG is used for LED<sub>y</sub> (Y=2, 5, 8, ..., 23), WBB is used for LED<sub>z</sub> (Z=3, 6, 9, ..., 24). The default value of registers WBR/WBG/WBB is 0xff.

Each LED current of AW21024 features 8bit DC current and 8bit PWM modulated current that are decided by COL source and BR source respectively. The BR and COL sources are as follows.

Mode	General Mode			Breathing Pattern Controller (BPC)			Group Control Mode		
Parameter Source	GEn=0			GEn=1 and PATEN=1			GEn=1 and PATEN=0		
	BR Source		COL Source	BR Source	COL Source		BR Source	COL Source	
LED NO.	RGBMD=0	RGBMD=1			GCOLDIS=0	GCOLDIS=1		GCOLDIS=0	GCOLDIS=1
#1	BR0	BR0	COL0	BPC	GCOLR	COL0	FADEL	GCOLR	COL0
#2	BR1	BR0	COL1		GCOLG	COL1		GCOLG	COL1
#3	BR2	BR0	COL2		GCOLB	COL2		GCOLB	COL2
#4	BR3	BR1	COL3		GCOLR	COL3		GCOLR	COL3
#5	BR4	BR1	COL4		GCOLG	COL4		GCOLG	COL4
#6	BR5	BR1	COL5		GCOLB	COL5		GCOLB	COL5
...	...	...	...		...	...		...	...
#22	BR21	BR7	COL21		GCOLR	COL21		GCOLR	COL21
#23	BR22	BR7	COL22		GCOLG	COL22		GCOLG	COL22
#24	BR23	BR7	COL23		GCOLB	COL23		GCOLB	COL23

#### Notes:

GEn (n=0~7) refers to BPC/Group-Control-Mode control bit in register GCFG0 (address ABh). PATEN is BPC control bit in register PATCFG (address A0h), GCOLDIS is group color disable bit in register GCFG1 (address ACh), GCOLR/GCOLG/GCOLB is for group color control decided by register GCOLR/GCOLG/GCOLB (address A8h~A9h). More details will be introduced later.

#### Update

After configuring the BR parameters, should write 0x00 to register UPDATE (address 49h) to update the data.

#### PWM Modulation

##### PWM Frequency

The PWM frequency is decided by bits CLKFRQ [2:0] in register GCR (address 00h). Following table shows the relationship of PWM frequency and the CLKFRQ [2:0]. To avoid the MLCC audible noise, it's recommended to use the PWM frequency lower than 500Hz or higher than 20kHz.

CLKFRQ[2:0]	000	001	010	011	100	101	110	111
PWM Freq. [Hz]	62k	32k	4k	2k	1k	500	244	122

##### PWM Phase Control

To reduce the peak load current and ceramic-capacitor audible ringing, AW21024 supports 4 PWM phase shifting (Phase1~Phase4) and phase-inverting scheme. When setting PDE in register PHCR (address 70h) to "1", the phase shifting scheme is enabled, and each adjacent phase differs by 60 degrees, which meaning only 6 of 24 LEDs could switch on in the same time.

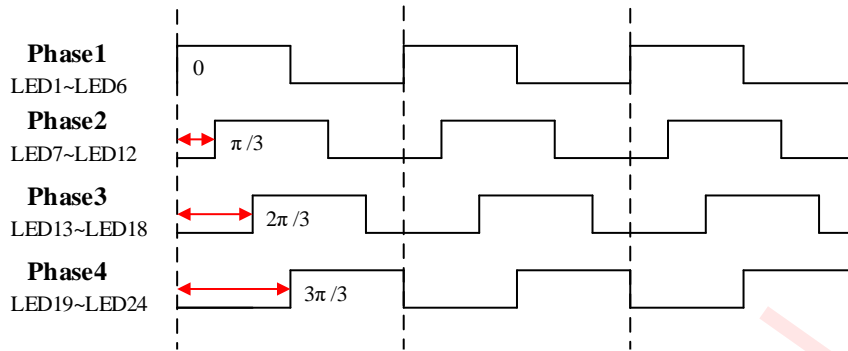


Figure 7 Phase Shift Scheme

When setting  $PIE_n$  in register PHCR (address 70h,  $n=1\sim 4$ ) to “1”, the PWM phase of the even-numbered channels is inverted. As shown below, if setting  $PIE_n$  to “1”, the even-numbered channels (i.e.  $6x(n-1)+2$ ,  $6x(n-1)+4$ ,  $6(n-1)+6$ ) are switched off when the odd-numbered channels (i.e.  $6x(n-1)+1$ ,  $6x(n-1)+3$ ,  $6(n-1)+5$ ) are switched on, which is good for reducing the input-current ripple. For an example, when setting  $PIE_0$  to “1”, the channels of LED2, LED4 and LED6 are switched off when the channels of LED1, LED3 and LED5 are switched on.

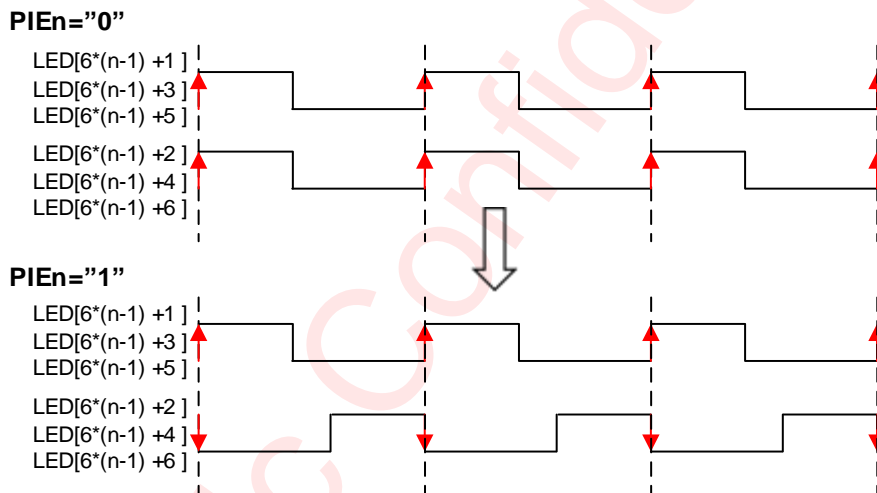


Figure 8 Phase Invert Scheme

### PWM Disable

If the bits PWMDIS [1:0] in register SSCR (address 78h) is set to “11”, the PWM output is disabled, and the duty of each PWM is forced to 100%. In this mode, the BR parameter is not valid, but the COL parameter is still effective. And the PWM outputs of LED1~12 and LED13~24 enabled or not are decided by the bit 0~1 of PWMDIS respectively.

It should be noted that when performing open-short detection, the bits PWMDIS [1:0] need to be set to “11”.

### Spread Spectrum

PWM is a troublesome for some application which is concerned about EMI. AW21024 has spread spectrum function to optimize the EMI performance. If bit SSE in register SSCR (address 78h) is set to “1”, spread spectrum function is enabled. By setting the bit SSR in register SSCR, four spread spectrum range 5%/15%/25%/35% can be selected. The total electromagnetic emitting energy can spread into a wider range of frequency band that significantly degrades the peak energy of EMI.

## RGB Configure Mode

To achieve fast register configuration for RGB applications, AW21024 provides an RGB configuration mode by setting the bit RGBMD in register GCR2 (address 7Ah). In RGB mode, every 3 adjacent LEDs share a same BR parameter.

If RGBMD=1, register BR0~BR7 configure brightness parameters for corresponding 8 RGB groups (every 3 adjacent LEDs form a RGB group). In other words, in RGB mode, only registers BR0~BR7 need to be configured, and the registers BR8~BR23 not valid any more.

If RGBMD=0, register BR0~BR23 configure brightness parameters for corresponding 24 LEDs independently, more details as follows,

LED No.	BR parameter source	
	RGBMD=0	RGBMD=1
#1	BR0	BR0
#2	BR1	
#3	BR2	
#4	BR3	BR1
#5	BR4	
#6	BR5	
...	...	...
#22	BR21	BR7
#23	BR22	
#24	BR23	

## Pattern Controllers

There is a breathing pattern controller (BPC) in the device. When bit PATEN in register PATCGF (address A0h) is set to "1", breathing pattern controller is enabled. Pattern controller can be configured as autonomous breathing mode or manual-controlled mode. Each RGB consisting of every three adjacent LEDs can be configured as pattern controlled mode or normal mode by register GCFG0. For example, when setting GCFG0 = 0x01 and PATEN=1, the RGB1 which consists of LED1~LED3 will work in BPC mode and other LED will work in normal mode.

### Autonomous Breathing Mode

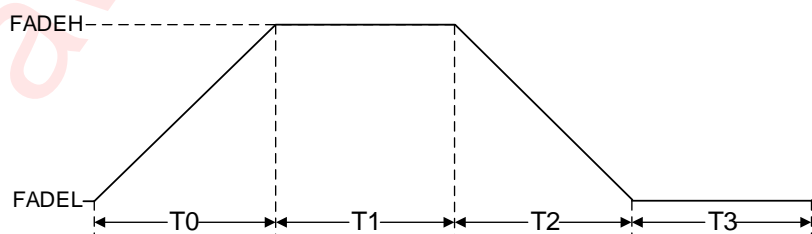


Figure 9 LED Breath Timing in Pattern Mode

When bit PATMD in register PATCFG is set to "1", the pattern controller works in autonomous breathing mode. In this mode, the pattern controller will generate a breathing lighting effect, which is configured by the user-defined timing parameter. The waveform of the breathing lighting effect is shown in the following figure. The parameter T0~T3 define 4 key periods in a complete breathing cycle. T0~T3 composite a breathing loop, denoting the rise-time, on-time, fall-time and off-time respectively. Register FADEH (A6h) and FADEL (A7h)

control the max and min brightness of the breathing respectively.

The start point and end point of autonomous breathing loop are configurable. The loop starting point could be selected among T0~T3, which is set by bits LB [1:0] in register PATT2 (address A4h). The end point of the loop can only be selected between the end of T0 and the end of T2, which is determined by bits LE [1:0] in register PATT2. The repeat times is determined by the end point defined. If bits LE [1:0] is not "00", the end point of breathing loop is the end of T0, and the loop counter increment by 1 at the end of T0. If bit LE [1:0] is "00", the loop end point is the end of T2, and the loop counter increment by 1 at the end of T2.

The repeat times is decided by bit RPT [11:8] of register PATT2 (address A4h) and RPT [7:0] of register PATT3 (address A5h). When setting RPT [11:0] to "0", the breathing pattern will run unlimited times.

After the breathing pattern is over, the status bit ENDFLAG in register PATGO (address A2h) will be set to "1", and ENDFLAG will be cleared to "1" after reading out through I<sup>2</sup>C bus. Once breathing loop start again or pattern controller switches to manual mode by setting PATMD bit to "0", the ENDFLAG will also be cleared.

When bit RUN in register PATGO is set to "1", breathing pattern is started. The full process of the autonomous breathing is as follows:

- Set GCOLR/G/B, FADEH/L parameter.
- Set GCFG0 to select the LED in breathing pattern mode or not.
- Configure PATT0, PATT1, PATT2, and PATT3 for parameters T0~T3, start/stop point, and repeat times.
- Set PATEN=1 to enable breathing pattern mode.
- Set PATMD=1 and RAMPE=1 to select auto breathing mode and enable breathing ramp.
- Set RUN=1 to start the breath pattern.

### Manual Control Mode

If bit PATMD is set to "0", manual control mode is selected. In manual control mode, user could program the bit SWITCH of register PATCFG to control the output of pattern controller. When bit SWITCH is "1", the output of pattern controller is decided by register FADEH. When bit SWITCH is set as "0", the output is the decided by register FADEL.

If bit RAMPE in register PATCFG is set to "1", the smooth ramp up/down will be enabled. At the same time, if SWITCH changes from "0" to "1", the output will be ramp up to FADEH smoothly. Similarly, if SWITCH changes from "1" to "0", the output of the pattern controller will ramp down to FADEL smoothly.

However, if the RAMPE is set to "0", the output of the pattern controller will change to FADEH or FADEL directly with no ramp as the SWITCH changes.

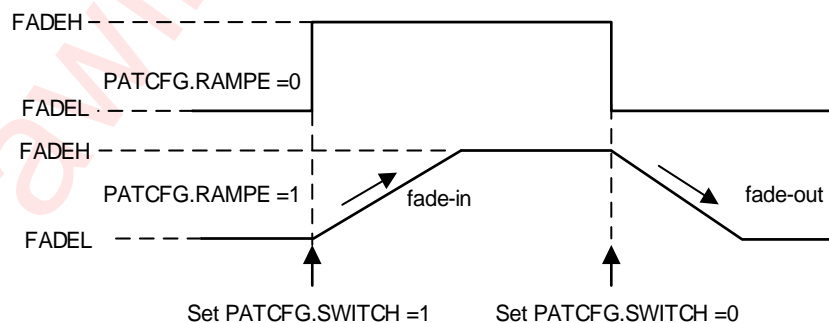


Figure 10 Manual Control Mode



## Register Configuration

## Register List

ADDR	NAME	W/R	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	Default		
00H	GCR	W/R	APSE	CLKFRQ			-			CHIPEN	00H		
01H ~ 18H	BR0~BR23	W/R	BR0~BR23									00H	
49H	UPDATE	W	UPDATE									00H	
4AH ~ 61H	COL0 ~ COL23	W/R	COL0~COL23									00H	
6EH	GCCR	W/R	GCC									00H	
70H	PHCR	W/R	PDE	-			PIE				00H		
71H	OSDCR	W/R	-				OTH	STH	OSDE			00H	
72H	OSST0	R	OSST [7:0]									00H	
73H	OSST1	R	OSST [15:8]									00H	
74H	OSST2	R	OSST [23:16]									00H	
77H	OTCR	W/R	TROF		TRST	OTST	OTPD	OTDIS	TRTH			00H	
78H	SSCR	W/R	-	PWMDIS		SSE	SSR		CLT			00H	
79H	UVCR	W/R	REXT_ST		UVST	PORST	OCPTH	OCPD	UVPD	UVDIS	00H		
7AH	GCR2	W/R	-								RGBMD	00H	
7CH	GCR4	-	-					SRR	SRF			00H	
7EH	VER	R	VERSION									A8H	
7FH	RESET	W/R	RESET/ID									18H	
90H	WBR	W/R	WBR									FFH	
91H	WBG	W/R	WBG									FFH	
92H	WBB	W/R	WBB									FFH	
A0H	PATCFG	W/R	-				SWITC H	RAMP E	PATM D	PATEN			00H
A1H	PATGO	W/R	-						ENDF LAG	PATS T	RUN		00H
A2H	PATT0	W/R	T0				T1					00H	
A3H	PATT1	W/R	T2				T3					00H	
A4H	PATT2	W/R	LE		LB		RPT[11:8]					00H	
A5H	PATT3	W/R	RPT[7:0]									00H	
A6H	FADEH	W/R	FADEH									00H	
A7H	FADEL	W/R	FADEL									00H	
A8H	GCOLR	W/R	GCOLR									00H	
A9H	GCOLG	W/R	GCOLG									00H	
AAH	GCOLB	W/R	GCOLB									00H	
ABH	GCFG0	W/R	GE7	GE6	GE5	GE4	GE3	GE2	GE1	GE0	00H		
ACH	GCFG1	W/R	-	-	-	GCOL DIS	-					00H	

## Register Detailed Description

## GCR: Global Control Register(Address 00H)

Bit	Symbol	R/W	Description	Default
7	APSE	RW	Auto power-saving mode enable 0: Disable 1: Enable	0
6:4	CLKFRQ	RW	OSC frequency selection 000: 16MHz 001: 8MHz 010: 1MHz 011: 512kHz 100: 256kHz 101: 125kHz 110: 62.5kHz 111: 31.25kHz	000
3:1	RESERVED	R	Reserved	0
0	CHIPEN	RW	Chip enable 0: Disable (default) 1: Enable	0

## BR: BR Register(Address 01H~18H)

Bit	Symbol	R/W	Description	Default
7:0	BR	RW	Individual 8bit BR parameter for LED1~24 After configuring the BR registers, should write 0x00 to register UPDATE to update the data.	0x00

## UPDATE: Update Register(Address 49H)

Bit	Symbol	R/W	Description	Default
7:0	UPDATE	W	Write 0x00 to update BR register.	0x00

## COL0~COL35: COL Register(Address 4AH~61H)

Bit	Symbol	R/W	Description	Default
7:0	COL	RW	Individual 8bit COL parameter for LED1~24.	0x00

## GCCR: Global Control Register(Address 6EH)

Bit	Symbol	R/W	Description	Default
7:0	GCC	RW	Global current control.	0x00

**PHCR: Phase Control Register(Address 70H)**

Bit	Symbol	R/W	Description	Default
7	PDE	RW	PWM phase delay enable 0: Disable 1: Enable	0
6:4	RESERVED	R	Reserved	0
3	PIE3	RW	PWM phase invert for LED20, LED22 and LED24 0: Phase invert disabled 1: Phase invert enabled	0
2	PIE2	RW	PWM phase invert for LED14, LED16 and LED18 0: Phase invert disabled 1: Phase invert enabled	0
1	PIE1	RW	PWM phase invert for LED8, LED10 and LED12 0: Phase invert disabled 1: Phase invert enabled	0
0	PIE0	RW	PWM phase invert for LED2, LED4 and LED6 0: Phase invert disabled 1: Phase invert enabled	0

**OSDCR: Open Short Detect Control Register(Address 71H)**

Bit	Symbol	R/W	Description	Default
7:4	RESERVED	R	Reserved	0000
3	OTH	RW	Open threshold 0: 0.1V 1: 0.2V	0
2	STH	RW	Short threshold 0: VDD-1V 1: VDD-0.5V	0
1:0	OSDE	RW	Open short detect enable 0x: Detect disable 10: Short detect enable 11: Open detect enable	00

**OSST0~2: Open/Short Status Register (Address 72H~74H)**

Bit	Symbol	R/W	Description	Default
7:0	OSST	R	Open/short status of LED1~LED24 0: No open/short event detected 1: Open/short event detected	0x00

**OTCR: Over Temperature Control Register (Address 77H)**

Bit	Symbol	R/W	Description	Default
7:6	TROF	RW	Thermal roll off percentage of I <sub>OUT</sub> 00: 100% 01: 75% 10: 55% 11: 30%	00
5	TRST	R	Thermal roll off status 0: None roll off 1: Roll off	0
4	OTST	R	Over-temperature status 0: None over-temperature 1: Over-temperature	0
3	OTPD	RW	Over-temperature(OT) protect disable 0: OT protect enable, when OT event occurs, device will clear GCR.CHIPEN to 0. 1: OT protect disable	0
2	OTDIS	RW	Over-temperature detect disable 0: OT detect enable, when OT event occurs, OTCR.OTST will be set. 1: OT detect disable	0
1:0	TRTH	RW	Thermal roll off threshold 00: 140°C 01: 120°C 10: 100°C 11: 90°C	00

**SSCR: Spread Spectrum Control Register (Address 78H)**

Bit	Symbol	R/W	Description	Default
7	RESERVED	R	Reserved	0
6	PWMDIS1	RW	0: PWM duty of LED 13~24 determined by BR12~BR23 1: PWM duty of LED 13~24 fixed as 100%	0
5	PWMDIS0	RW	0: PWM duty of LED 1~12 determined by BR0~BR11 1: PWM duty of LED 1~12 fixed as 100%	0
4	SSE	RW	Spread spectrum enable 0: Disable 1: Enable	0
3:2	SSR	RW	Spread spectrum range 00: ±5% 01: ±15% 10: ±25% 11: ±35%	00

1:0	CLT	RW	Spread spectrum cycle time 00: 1980 $\mu$ s (default) 01: 1200 $\mu$ s 10: 820 $\mu$ s 11: 660 $\mu$ s	00
-----	-----	----	--	----

**UVCR: UVLO Control Register (Address 79H)**

Bit	Symbol	R/W	Description	Default
7:6	REXT_ST	R	R <sub>EXT</sub> status 00: Normal 10: R <sub>EXT</sub> is open 01: R <sub>EXT</sub> is short or OCP 11: Not defined	00
5	UVST	R	UVLO status 0: No UVLO detected 1: UVLO detected	0
4	PORST	R	Power-up reset status 0: No power-on reset 1: Power-on reset (cleared after read out)	0
3	OCPTH	RW	OCP Threshold 0: 85mA 1: 55mA	0
2	OCPD	RW	OCP disable 0: enable OCP 1: disable OCP	0
1	UVPD	RW	UVLO protect disable 0: UVLO protect enable, when under-voltage event occurs, device will clear GCR.CHIPEN to 0. 1: UVLO protect disable	0
0	UVDIS	RW	UVLO detect disable 0: UVLO detect enable, when under-voltage event occurs, UVCR.UVST will be set. 1: UVLO detect disable	0

**GCR2: Global Control Register 2(Address 7AH)**

Bit	Symbol	R/W	Description	Default
7:1	RESERVED	R	Reserved	0000 000
0	RGBMD	RW	RGB configure mode enable 0: Disable 1: Enable, every 3 LEDs share a common brightness.	0

**GCR4: Global Control Register 4(Address 7CH)**

Bit	Symbol	R/W	Description	Default
7:3	RESERVED	R	Reserved	0000 0
2	SRR	RW	Slew rate control for LED output rising time 0: 1ns 1: 6ns	0
1:0	SRF	RW	Slew rate control for LED output falling time 00: 1ns 01: 3ns 10: 6ns 11:10ns	00

**VER: Version Register (Address 7Eh)**

Bit	Symbol	R/W	Description	Default
7:0	VER	R	Chip version	0xA8

**RESET: Software Reset Register (Address 7FH)**

Bit	Symbol	R/W	Description	Default
7:0	RESET	RW	Write 00H to the register will reset all registers to their default value. The chip ID 0x18 will be read out from the register.	0x18

**WBR: Red Scaling for White Balance(Address 90H)**

Bit	Symbol	R/W	Description	Default
7:0	WBR	RW	Red Scaling for White Balance.	0xFF

**WBG: Green Scaling for White Balance(Address 91H)**

Bit	Symbol	R/W	Description	Default
7:0	WBG	RW	Green Scaling for White Balance.	0xFF

**WBB: Blue Scaling for White Balance(Address 92H)**

Bit	Symbol	R/W	Description	Default
7:0	WBB	RW	Blue Scaling for White Balance.	0xFF

**PATCFG: Pattern Configure Register(Address A0H)**

Bit	Symbol	R/W	Description	Default
7:4	RESERVED	R	Reserved	0000
3	SWITCH	RW	Switch on or off at manual mode. 0: LED off 1: LED on	0
2	RAMPE	RW	Ramp enable 0: Ramp disable 1: Ramp enable	0
1	MODE	RW	Breath pattern control mode selection 0: Manual mode (default) 1: Auto breath pattern mode	0
0	PATEN	RW	Auto breath pattern controller enable 0: Disable 1: Enable	0

**PATGO: Pattern Configure Register(Address A1H)**

Bit	Symbol	R/W	Description	Default
7:3	RESERVED	R	Reserved	0000 0
2	ENDFLG	R	Auto breath pattern loop end flag 0: Loop is not over 1: Loop is over (will be cleared after reading out)	0
1	STATE	R	Auto breath pattern status 0: Pattern is stop 1: Pattern is running	0
0	RUN	RW	Auto breath pattern run control Write "1" to run auto breath pattern Note: You shall write "0" and then write "1" to this bit to restart a new auto breath pattern.	0

**PATT0: Pattern Timer0(Address A2H)**

Bit	Symbol	R/W	Description	Default																																				
7:4	RISE	RW	Ramp rise time <table border="1" style="margin-left: 20px;"> <thead> <tr> <th>T0</th> <th>Time</th> <th>T0</th> <th>Time</th> </tr> </thead> <tbody> <tr> <td>0000</td> <td>0s</td> <td>1000</td> <td>2.1s</td> </tr> <tr> <td>0001</td> <td>0.13s</td> <td>1001</td> <td>2.6s</td> </tr> <tr> <td>0010</td> <td>0.26s</td> <td>1010</td> <td>3.1s</td> </tr> <tr> <td>0011</td> <td>0.38s</td> <td>1011</td> <td>4.2s</td> </tr> <tr> <td>0100</td> <td>0.51s</td> <td>1100</td> <td>5.2s</td> </tr> <tr> <td>0101</td> <td>0.77s</td> <td>1101</td> <td>6.2s</td> </tr> <tr> <td>0110</td> <td>1.04s</td> <td>1110</td> <td>7.3s</td> </tr> <tr> <td>0111</td> <td>1.6s</td> <td>1111</td> <td>8.3s</td> </tr> </tbody> </table>	T0	Time	T0	Time	0000	0s	1000	2.1s	0001	0.13s	1001	2.6s	0010	0.26s	1010	3.1s	0011	0.38s	1011	4.2s	0100	0.51s	1100	5.2s	0101	0.77s	1101	6.2s	0110	1.04s	1110	7.3s	0111	1.6s	1111	8.3s	0000
T0	Time	T0	Time																																					
0000	0s	1000	2.1s																																					
0001	0.13s	1001	2.6s																																					
0010	0.26s	1010	3.1s																																					
0011	0.38s	1011	4.2s																																					
0100	0.51s	1100	5.2s																																					
0101	0.77s	1101	6.2s																																					
0110	1.04s	1110	7.3s																																					
0111	1.6s	1111	8.3s																																					

3:0	ON	RW	Hold on time				0000
			T1	Time	T1	Time	
			0000	0.04s	1000	2.1s	
			0001	0.13s	1001	2.6s	
			0010	0.26s	1010	3.1s	
			0011	0.38s	1011	4.2s	
			0100	0.51s	1100	5.2s	
			0101	0.77s	1101	6.2s	
			0110	1.04s	1110	7.3s	
			0111	1.6s	1111	8.3s	

**PATT1: Pattern Timer1(Address A3H)**

Bit	Symbol	R/W	Description				Default
7:4	FALL	RW	Ramp fall time				0000
			T2	Time	T2	Time	
			0000	0s	1000	2.1s	
			0001	0.13s	1001	2.6s	
			0010	0.26s	1010	3.1s	
			0011	0.38s	1011	4.2s	
			0100	0.51s	1100	5.2s	
			0101	0.77s	1101	6.2s	
			0110	1.04s	1110	7.3s	
			0111	1.6s	1111	8.3s	
3:0	OFF	RW	Hold off time				0000
			T3	Time	T3	Time	
			0000	0.04s	1000	2.1s	
			0001	0.13s	1001	2.6s	
			0010	0.26s	1010	3.1s	
			0011	0.38s	1011	4.2s	
			0100	0.51s	1100	5.2s	
			0101	0.77s	1101	6.2s	
			0110	1.04s	1110	7.3s	
			0111	1.6s	1111	8.3s	

**PATT2: Pattern Control Register 1(Address A4H)**

Bit	Symbol	R/W	Description	Default
7:6	LE	RW	End point of the auto-breath pattern 00: Pattern finally stop at OFF state Other: Pattern finally stop at ON state	00
5:4	LB	RW	Start point of the auto-breath loop pattern 00: Pattern start from RISE state 01: Pattern start from ON state	00



			10: Pattern start from FALL state 11: Pattern start from OFF state	
3:0	RPT[11:8]	RW	4 MSB of loop times.	0000

**PATT3: Pattern Control Register 2 (Address A5H)**

Bit	Symbol	R/W	Description	Default
7:0	RPT[7:0]	RW	8 LSB of auto-breath pattern repeat times Note: when RPT[11:0]=0, the pattern will run forever. In this case, you can switch auto-breath mode to manual mode and then turn the pattern off.	0x00

**FADEH: Maximum Brightness for Auto Breath (Address A6H)**

Bit	Symbol	R/W	Description	Default
7:0	FADEH	RW	Maximum brightness configure for auto breath.	0x00

**FADEL: Minimum Brightness for Auto Breath(Address A7H)**

Bit	Symbol	R/W	Description	Default
7:0	FADEL	RW	Minimum brightness configure for auto breath.	0x00

**GCOLR: Red Mixing for Group Color (Address A8H)**

Bit	Symbol	R/W	Description	Default
7:0	GCOLR	RW	Red mixing for group color.	0x00

**GCOLG: Green Mixing for Group Color(Address A9H)**

Bit	Symbol	R/W	Description	Default
7:0	GCOLG	RW	Green mixing for group color.	0x00

**GCOLB: Blue Mixing for Group Color(Address AAH)**

Bit	Symbol	R/W	Description	Default
7:0	GCOLB	RW	Blue mixing for group color.	0x00

**GCFG0: Group Configure Register0 (Address ABH)**

Bit	Symbol	R/W	Description	Default
7:0	GE[7:0]	RW	<p>Group-Control-Mode/Pattern-Control-Mode enable for LED1~LED24</p> <p>If bit PATEN in register PATCFG is set to “0”,</p> <p>GE[0]=1: LED1~3 work in group mode            GE[1]=1: LED4~6 work in group mode            GE[2]=1: LED7~9 work in group mode            GE[3]=1: LED10~12 work in group mode            GE[4]=1: LED13~15 work in group mode            GE[5]=1: LED16~18 work in group mode            GE[6]=1: LED19~21 work in group mode            GE[7]=1: LED22~24 work in group mode</p> <p>If bit PATEN in register PATCFG is set to “1”,</p> <p>GE[0]=1: LED1~3 work in auto breath pattern mode            GE[1]=1: LED4~6 work in auto breath pattern mode            GE[2]=1: LED7~9 work in auto breath pattern mode            GE[3]=1: LED10~12 work in auto breath pattern mode            GE[4]=1: LED13~15 work in auto breath pattern mode            GE[5]=1: LED16~18 work in auto breath pattern mode            GE[6]=1: LED19~21 work in auto breath pattern mode            GE[7]=1: LED22~24 work in auto breath pattern mode</p>	0x00

**GCFG1: Group Configure Register1 (Address ACH)**

Bit	Symbol	R/W	Description	Default
7:5	RESERVED	R	Reserved	000
4	GCOLDIS	RW	<p>Group/pattern color disable</p> <p>0: Group/pattern color enable, all LEDs in group/pattern mode share the common COL parameters decided by GCOL_R/G/B.</p> <p>1: Group/pattern color disable, all LEDs' color parameter in group/pattern mode is configured by their respective register COL.</p>	0
3:0	RESERVED	R	Reserved	0000

## Application Information

### R<sub>EXT</sub>

The selection of R<sub>EXT</sub> determined the maximum LED1~LED24 current I<sub>MAX</sub> as described in below formula (1).

$$I_{MAX} = K \times \frac{V_{REXT}}{R_{EXT}} \quad (1)$$

Where V<sub>REXT</sub> = 0.4V, K = 200, the recommended minimum value of R<sub>EXT</sub> is 1.6kΩ.

When R<sub>EXT</sub> = 2kΩ, I<sub>MAX</sub> = 40mA.

When R<sub>EXT</sub> = 4kΩ, I<sub>MAX</sub> = 20mA.

### R<sub>R</sub>, R<sub>G</sub>, R<sub>B</sub>

The resistance(R<sub>x</sub>) used for thermal reduction can be calculated according to the following formula:

$$R_x = \frac{V_{LED} - V_{F_x} - V_{DROPOUT}}{I_{MAX}} \quad (2)$$

V<sub>LED</sub>: LED power supply voltage.

V<sub>F<sub>x</sub></sub>: LED forward voltage.

V<sub>DROPOUT</sub>: Voltage on LED<sub>x</sub>, recommended values is 0.5V.

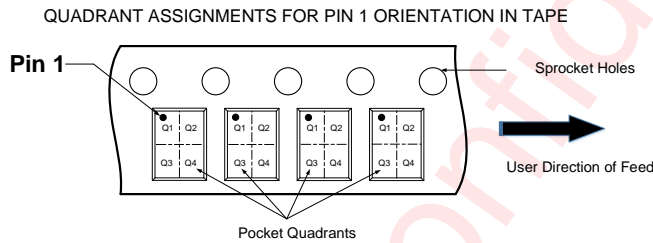
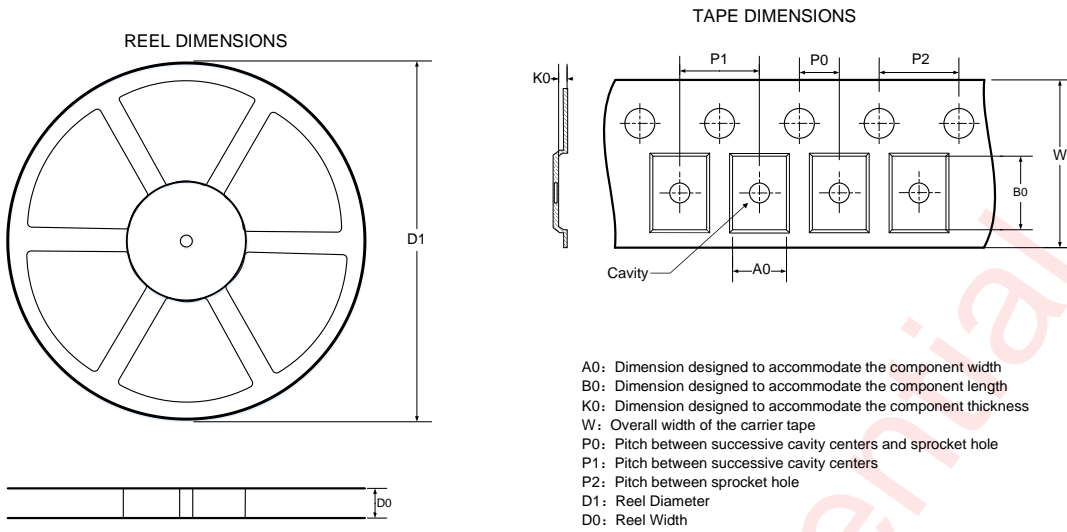
I<sub>MAX</sub>: Global current.

## PCB Layout Consideration

AW21024 is a 24-channel LEDs driver programmed via I<sup>2</sup>C compatible interface. When all LEDs are operating, the device power dissipation is large. To obtain the good thermal performance and avoid thermal shutdown, PCB layout should be considered carefully. Here are some guidelines:

1. The C<sub>1</sub>, C<sub>2</sub>, C<sub>LED</sub> should be placed as close to the chip as possible.
2. The R<sub>EXT</sub> should be placed as close to the chip as possible.
3. The Thermal PAD must be well connecting to the GND of the PCB, and add as many thermal vias as possible beneath the thermal PAD on the PCB for the heat conductivity of the device and PCB.

## Tape And Reel Information

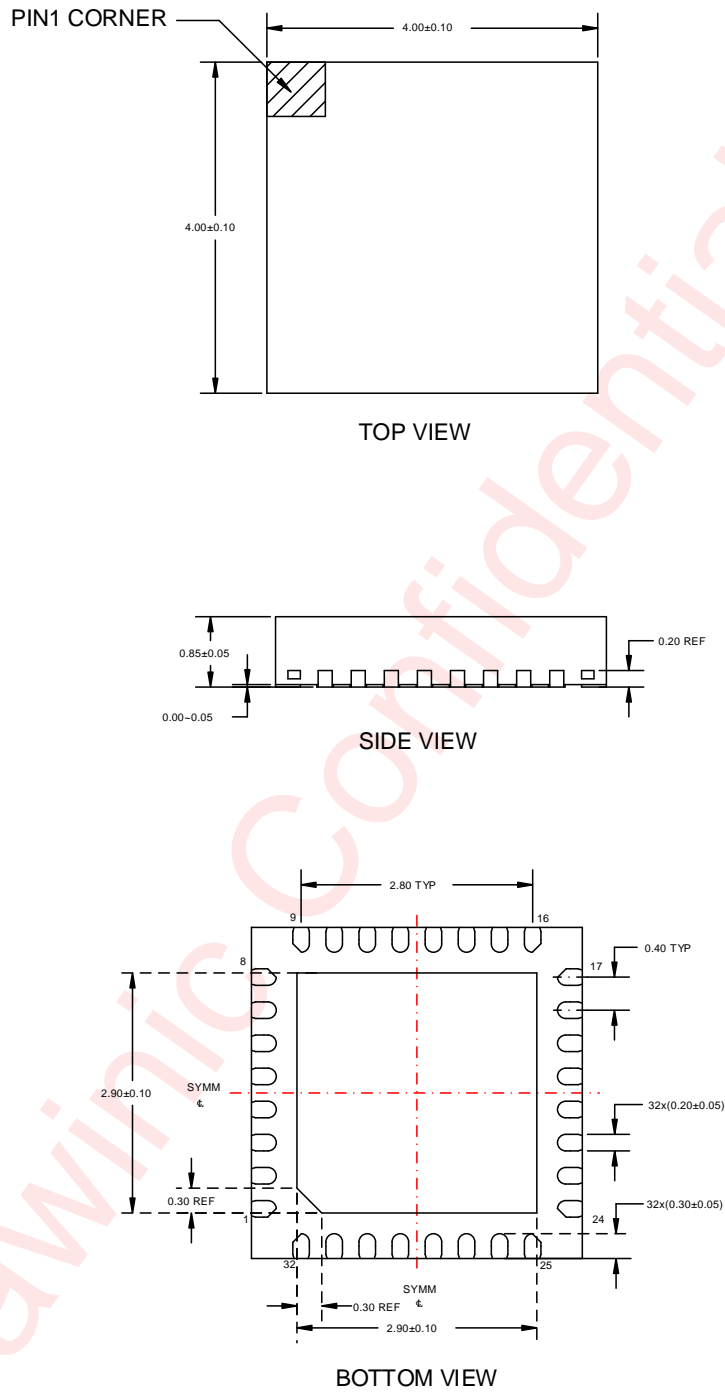


**DIMENSIONS AND PIN1 ORIENTATION**

D1 (mm)	D0 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
330	12.4	4.3	4.3	1.1	2	8	4	12	Q1

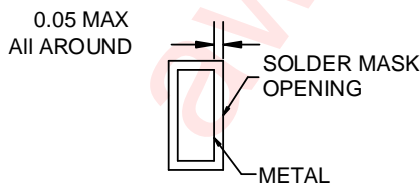
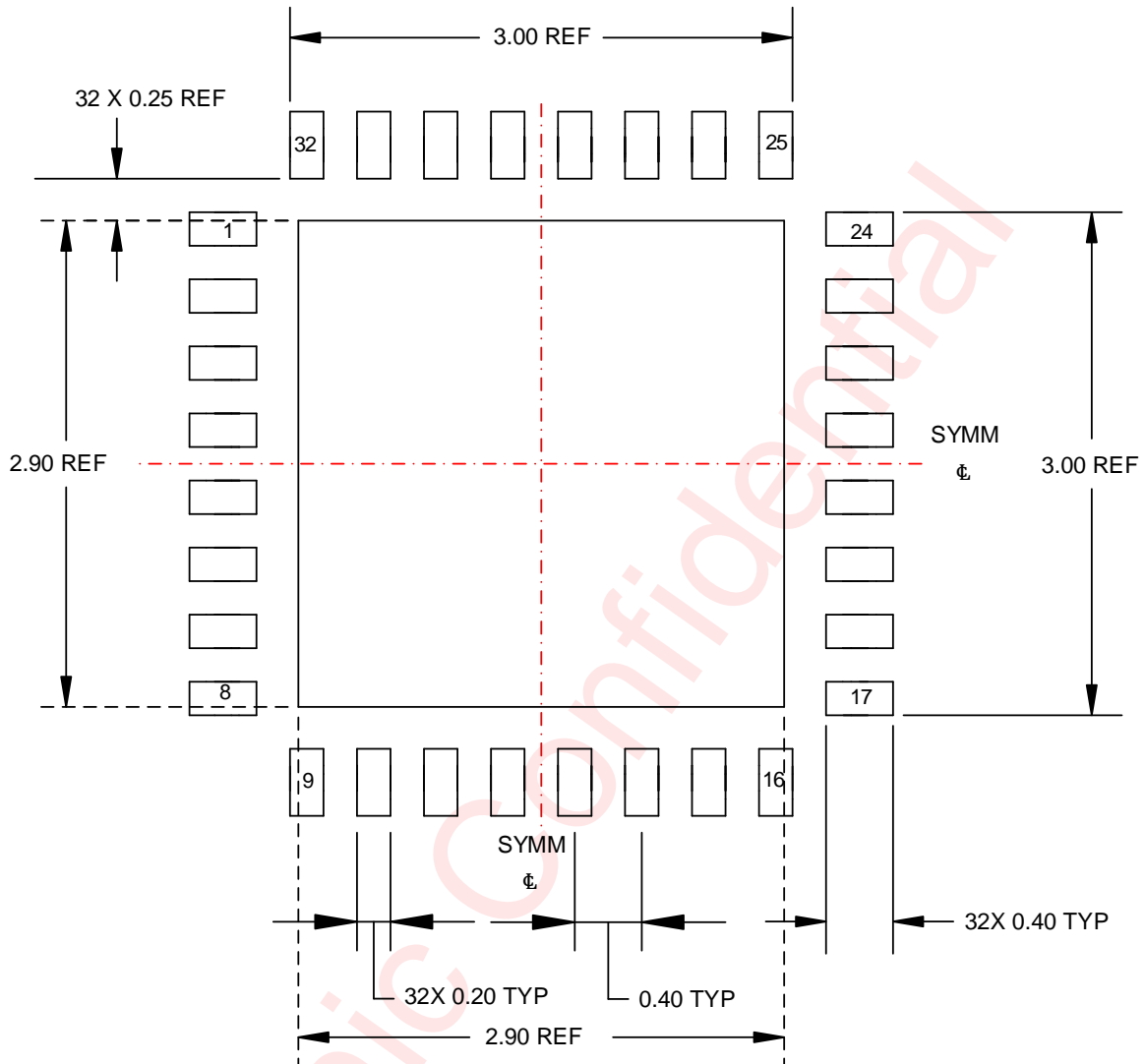
All dimensions are nominal

Package Description

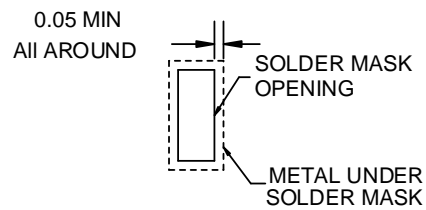


Unit: mm

Land Pattern Data



NON SOLDER MASK DEFINED



SOLDER MASK DEFINED

Unit: mm

## Revision History

Version	Date	Change Record
V1.0	Sep.2019	Officially released
V1.1	Nov.2021	Change device address
V1.2	Feb.2022	Modified EC table(VDD=2.7V~5.5V)
V1.3	May.2022	Modified description of standby mode
V1.4	Jul.2023	Added description of the auto power-save mode is disabled under autonomous breathing mode Page 8 Modified bit RAMPEN to bit RAMPE Page 16 Modified register UVCR description Page 21
V1.5	Nov. 2023	Modified General Description (P1). Modified Typical Application Circuit(replace Iout to I <sub>MAX</sub> ) (P1, P3). Updated the $\theta_{JA}$ in the table of Absolute Maximum Ratings (P4). Added Recommended Operation Condition (P4). Modified test condition and values of Dropout Voltage in EC table (P5). Modified figure Power Up Timing and Software Reset Timing (P7). Modified figure AW21024 Operating Mode Transition (P8). Modified figure I <sup>2</sup> C Write Byte Cycle (P11). Modified the description of Current Setting (P12). Modified the minimum value of R <sub>EXT</sub> in Application Information (P27). Added thermal reduction resistance formula in Application Information (P27).

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